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Understanding Embedded - Microprocessors

Embedded microprocessors are specialized computing chips designed to perform specific tasks within an embedded system. Unlike general-purpose microprocessors found in personal computers, embedded microprocessors are tailored for dedicated functions within larger systems, offering optimized performance, efficiency, and reliability. These microprocessors are integral to the operation of countless electronic devices, providing the computational power necessary for controlling processes, handling data, and managing communications.

Applications of Embedded - Microprocessors

Embedded microprocessors are utilized across a broad spectrum of applications, making them indispensable in

Details	
Product Status	Obsolete
Core Processor	Z16C00
Number of Cores/Bus Width	1 Core, 16-Bit
Speed	10MHz
Co-Processors/DSP	-
RAM Controllers	-
Graphics Acceleration	No
Display & Interface Controllers	-
Ethernet	-
SATA	-
USB	-
Voltage - I/O	5.0V
Operating Temperature	-40°C ~ 100°C (TA)
Security Features	-
Package / Case	40-DIP (0.620", 15.75mm)
Supplier Device Package	40-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/zilog/z16c0210pec

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong



Z16C01/C02

CPU CENTRAL PROCESSING UNIT

FEATURES

	Memory	Memory	Speed
Part	Address	Extension	(MHz)
Z16C01	8 Mbytes	48 Mbytes	10
Z16C02	64 Kbytes	384 Kbytes	10

- 40/48-Pin PDIP and 44-Pin PLCC Packages
- \blacksquare +4.5 ≤ V_{cc} ≤ +5.5-Volt Operating Range
- Low-Power CMOS
- 0°C to +70°C Temperature Range

- Extendable Register Files
- Nine Basic Instruction Types
- Eight User-Selectable Addressing Modes
- Seven Data Types
- Supports Three Interrupt Types and Four Traps
- RISC-Like Load/Store Architecture

GENERAL DESCRIPTION

The Z16C01/C02 CPU are members of the 16-bit processor and controller family. Designed using a RISC-like Load/Store architecture, the CPU can operate in either system or normal modes, permitting privileged operations and improving operating system organization and implementation.

To boost the main CPU's performance capability, the processor core includes hardwired control and is a 16-bit real-time processor functioning at register access speeds. Register flexibility is created by grouping or overlapping multiple registers, and by allowing extended register file capabilities as the system expands. Easy extended register file control is accomplished through a single instruction stream communication.

The CPU supports three types of interrupts (non-maskable, vectored, and non-vectored) and four traps (system call, extended process architecture instruction, privileged instructions, and segmentation trap). The vectored and non-vectored interrupts are maskable.

The processor's resources include seven data types that range from bits to 32-bit long words, and byte and word strings, plus eight user-selectable addressing modes. The nine basic instruction types can be combined with various data types and addressing modes to form a powerful set of 414 instructions.

The extended processing architecture features provide a modular approach to expanding both the hardware and software capabilities of the Z16C01/C02.

Notes:

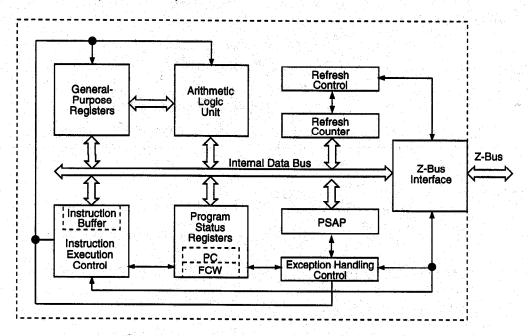
All Signals with a preceding front slash, "/", are active Low, e.g.: B/W (WORD is active Low); /B/W (BYTE is active Low, only).

Power connections follow conventional descriptions below:

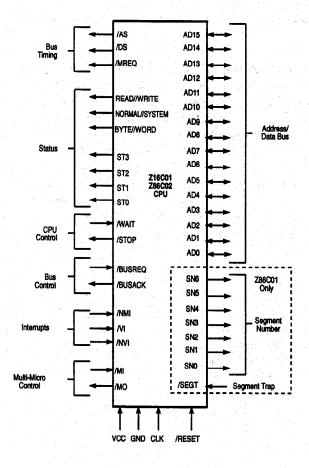
Connection	Circuit	Device
Power	V _{cc}	V _{DD}
Ground	GND	V _{SS}

CPS95SCC0103 (3/95)

GENERAL DESCRIPTION (Continued)

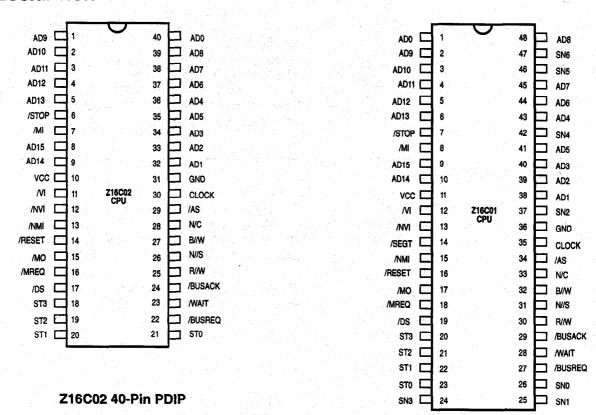


Z16C00 CPU Functional Block Diagram

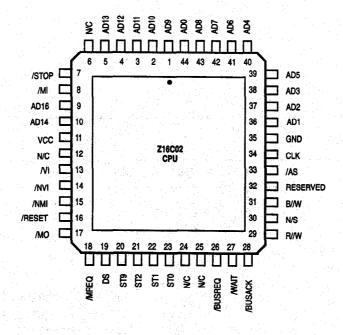


Z16C01/C02 Signal Descriptions

PIN DESCRIPTION



Z16C01 48-Pin PDIP



Z16C02 44-Pin PLCC

ABSOLUTE MAXIMUM RATINGS

Voltages on V _{cc} with respect to V _s	0.3V to +7.0V
Voltages on all inputs with respect	
V _{SS}	0.3V to V_{cc} +0.3V
Storage Temperature	

Stresses greater than those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; operating of the device at any condition above these indicated in the operational sections of these specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

STANDARD TEST CONDITIONS

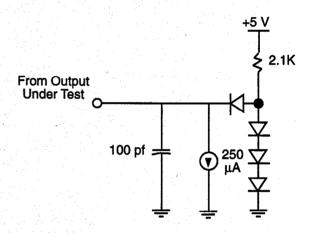
The DC characteristics below apply for the following test conditions, unless otherwise noted. All voltages are referenced to GND (0V). Positive current flows into the referenced pin.

Available operating temperature ranges are:

- S = 0°C to +70°C, + 4.5 $V \le V_{CC} \le$ + 5.5V (Z16C01, Z16C02)
- E = -40°C to +100°C, + 4.5V ≤ V_{cc} ≤ + 5.5V (Z16C01, Z16C02)

All AC parameters assume a total load capacitance (including parasitic capacitances) or 100 pf max, except for parameter 6 (50 pf max). Timing reference between two output signals assume a load difference of 50 pf max.

The Ordering Information section lists package temperature ranges and product numbers.



Test Load Diagram

DC CHARACTERISTICS

Sym	Parameter	MIN	MAX	Units	Condition	
V _{CH}	Clock Input High Voltage	V _{cc} -0.4	V _{cc} +0.3	٧	Driven by External Clock Generator	
V _{CL}	Clock input Low Voltage	~-0.3	ິັ0.45	٧	Driven by External Clock Generator	
V _{IH}	Input High Voltage	2.0	V _{cc} +0.3	٧		
V,,, RESET	Input High Voltage on /RESET Pin	2.4	V _{cc} +0.3	ν		
V _{IH} NMI	Input High Voltage on NMI Pin	2.4	V _{cc} +0.3	٧		
/ ,,	Input Low Voltage	-0.3	ິ 0.8	٧		
, oH	Output High Voltage	2.4		V	$I_{0H} = -250uA$	
OL OL	Output Low Voltage		0.4	V	$I_{01} = +2.0$ mA	
UL	Input Leakage		±10	μA	0.4V ≤ VIN ≤ +2.4V	
SEGT	Input Leakage on /SEGT Pin	-100	100	μΑ		
OL.	Output Leakage		±10	μA	0.4V ≤ VIN ≤ +2.4V	
CC	V _{cc} Power Supply Current		35	mΑ	10MHz	



FOOTNOTES TO AC CHARACTERISTICS

No.	Symbol	Z16C01/2 10 MHz Equation	
11 13 16 17 19	TdA(DR) TdDS(A) TdDW(DS) TdA(MR) TwMRh	2TcC+TwCh-60ns TwCl+5ns TcC+TwCh-30ns TwCh-20ns TcC-20ns	
20 21 22 25 27	TdMR(A) TdDW(DSW) TdMR(DR) TdA(AS) TdAS(DR)	TwCl-20ns TwCh-25ns 2TcC-60ns TwCh-20ns 2TcC-60ns	
28 29 30 32 33	TdDS(AS) TwAS TdAS(A) TdAS(DSR) TdDSR(DR)	TwCI-20ns TwCh-5ns TwCI-10ns TwCI-5ns TcC+TwCh-60ns	
35 36 38 40 41	TdDS(DW) TdA(DSR) TwDSR TwDSW TdDSI(DR)	TwCI-15ns TcC-35ns TcC+TwCh-30ns TcC-25ns 2TcC-80ns	
43 44 46 48 68 69	TwDS TdAS(DSA) TdDSA(DR) TdS(AS) TwA TdDS(s)	2TcC-40ns 4TcC+TwCl-30ns 2TcC+TwCh-75ns TwCh-20ns TcC-50ns TwCl-10ns	

AC Timing Test Conditions:

 $\begin{aligned} & V_{\text{OL}} = 0.8V \\ & V_{\text{OH}} = 2.0V \\ & V_{\text{IL}} = 0.8V \\ & V_{\text{IH}} = 2.4V \\ & V_{\text{ILC}} = 0.45V \\ & V_{\text{IHC}} = V_{\text{cc}} - 0.4V \end{aligned}$



AC CHARACTERISTICS

			Z16C01 10 MH	
No.	Symbol	Parameter	Min	Max
1	TcC	Clock Cycle Time	100	
2	TwCh	Clock Width (High)	40	
3	TwCl	Clock Width (Low)	40	
4	TfC	Clock Fall Time		10
5	TrC	Clock Rise Time		
6	TdC(SNv)	Clock+ Segment Number Valid (50pf load)		
7	TdC(SNn)	Clock +Segment Number Not Valid	0	
8	TdC(Bz)	Clock + Bus Float		50
9	TdC(A)	Clock +Address Valid		50
10	TdC(Az)	Clock + Address Float		50
11	TdA(DR)	Address Valid to Read Data Required Valid		180*
12	TsDR(C)	Read Data to Clock Fall Setup Time	20	
13	TdDS(A)	/DS+Address Active	45*	
14	TdC(DW)	Clock + Write Data Valid		. 60
15	ThDR(DS)	Read Data to /DS Rise Hold Time	0	
16	TdDW(DS)	Write Data Valid to /DS Rise Delay	110*	
17	TdA(MR)	Address Valid to /MREQ Fall Delay	20*	
18	TdC(MR)	Clock Fall to /MREQ Fall Delay		50
19	TwMRh	/MREQ Width (High)	80*	
20	TdMR(A)	/MPEO E Address Not Active	20*	
21		/MREQ [Address Not Active	20*	
22	TdDW(DSW)	Write Data Valid to /DS Fall (Write) Delay	15*	440#
	TdMR(DR)	/MREQ [Read Data Required Valid		140 * 20, 12 (12)
23	TdC(MR)	Clock Fall /MREQ Rise Delay		2 50
24	TdC(ASf)	Clock + /AS Fall Delay	004	35
25	TdA(AS)	Address Valid to /AS Rise Delay	20*	
26	TdC(ASr)	Clock [/AS Rise Delay		25
27	TdAS(DR)	/AS + Read Data Required Valid		. 140*
28	TdDS(AS)	/DS + /AS Fall Delay	20*	
29	TwAS	/AS Width (Low)	35*	
30	TdAS(A)	/AS + Address Not Active Delay	30*	
31	TdAz(DSR)	Address Float to /DS (Read) Fall Delay	0	
32	TdAS(DSR)	/AS + /DS (Read) Fall Delay		35*
33	TdDSR(DR)	/DS (Read) Fall to Read Data Required Valid		80*
34	TdC(DSr)	Clock Fall to /DS Rise Delay		30
35	TdDS(DW)	/DS + Write Data Not Valid	25*	
36	TdA(DSR)	Address Valid to /DS (Read) Fall Delay	65*	
37	TdC(DSR)	Clock Rise /DS (Read) Fall Delay		45
38	TwDSR	/DS (Read) Width (Low)	110*	
39	TdC(DSW)	Clock Fall to /DS (Write) Fall Delay		45 (46)
40	TwDSW	/DS (Write) Width (Low)	75*	
41	TdDSI(DR)	/DS (I/O) [Read Data Required Valid	34.44 BV	120*
42	TdC(DSf)	Clock [/DS (I/O) Fall Delay	Se CAND 2	45
43	TwDS	/DS (I/O) Width (Low)	160*	
44	TdAS(DSA)	/AS + /DS (Acknowledge) Fall Delay	410*	
45	TdC(DSA)	Clock + /DS (Acknowledge) Fall Delay		1 45
46	TdDSA(DR)	/DS (Acknowledge) [Read Data Required Delay		165*
47	TdC(S)	Clock Rise to Status Valid Delay		50
<u></u>				

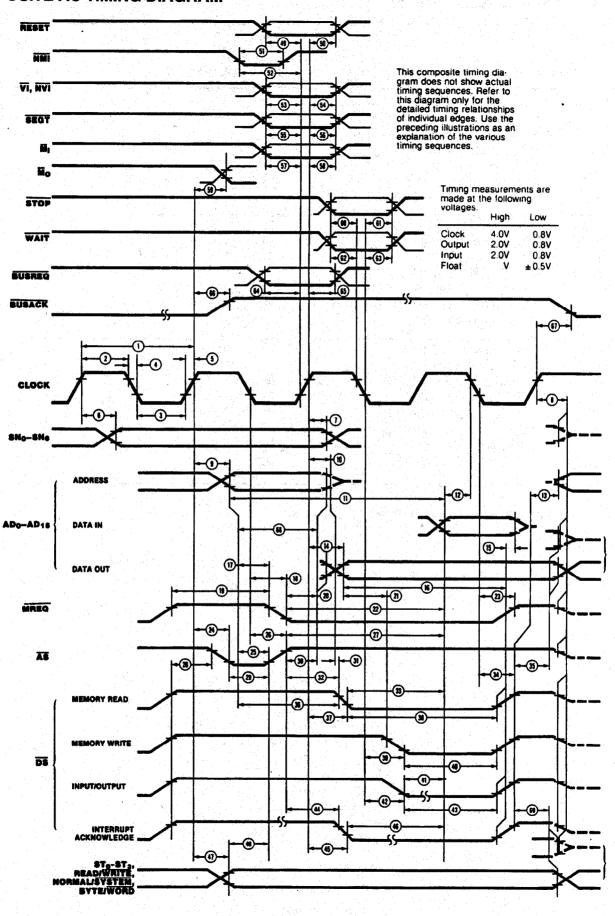


AC CHARACTERISTICS (Continued)

No.	Symbol	Parameter	Z16C01/2 10 MHz Min Max
48	TdS(AS)	Status Valid to /AS Rise Delay	20*
49	TsR(C)	/RESET to Clock Rise Setup Time	
50	ThR(C)	/RESET to Clock Rise Hold Time	
51 52	TwNMI TsNMI(C)	/NMI Width (Low)	
53	TsVI(C)	/NMI to Clock Rise Setup Time /VI, /NVI to Clock Rise Setup Time	7 (1) (1) (3) (3) (3) (4) (4) (4) (4) (4) (4) (4) (4) (4) (4
54	ThVI(C)	/VI, /NVI to Clock Rise Hold Time	
55	TsSGT(C)	/SEGT to Clock Rise Setup Time	35
56	ThSGT(C)	/SEGT to Clock Rise Hold Time	
57	TsMI(C)	/MI to Clock Rise Setup Time	
58 59	ThMI(C) TdC(MO)	/MI to Clock Rise Hold Time	
60	TsSTP(C)	Clock Rise to /MO Delay /STOP to Clock Fall Setup Time	7. Sec. 1997.
61	ThSTP(C)	/STOP to Clock Fall Hold Time	[4], \$14, 35
62	TsW(C)	/WAIT to Clock Fall Setup Time	20
63	ThW(C)	/WAIT to Clock Fall Hold Time	다리 2,5학 대로 생활하다. 후기 회가 가는 모든 모든 모든
64	TsBRQ(C)	/BUSREQ to Clock Rise Setup Time	원생 (kj. 35,) : [원생 (kj. 1 ki) : [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [원 (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [đ (kj. 1 ki)] (kj. 1 ki) [d (kj. 1
65	ThBRQ(C)	/BUSREQ to Clock Rise Hold Time	
66 67	TdC(BAKr)	Clock Rise to /BUSACK Rise Delay	를 하다고 하는 35 로만 급하는 것이 되고 있다.
68	TdC(BAKf) TwA	Clock Rise to /BUSACK Fall Delay Address Valid Width	35 En*
69	TdDS(S)	/DS Rise to STATUS Not Valid	50* 30*
		7-0	

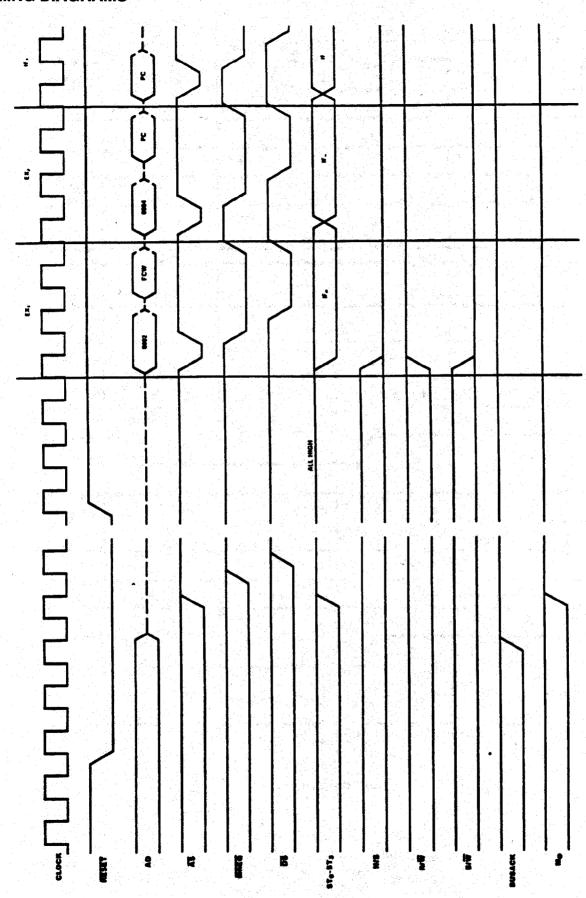
^{*} Clock-cycle time-dependent characteristics. See Footnotes to AC Characteristics. ** Clock may be stopped. † Units in nanoseconds (ns).

COMPOSITE AC TIMING DIAGRAM

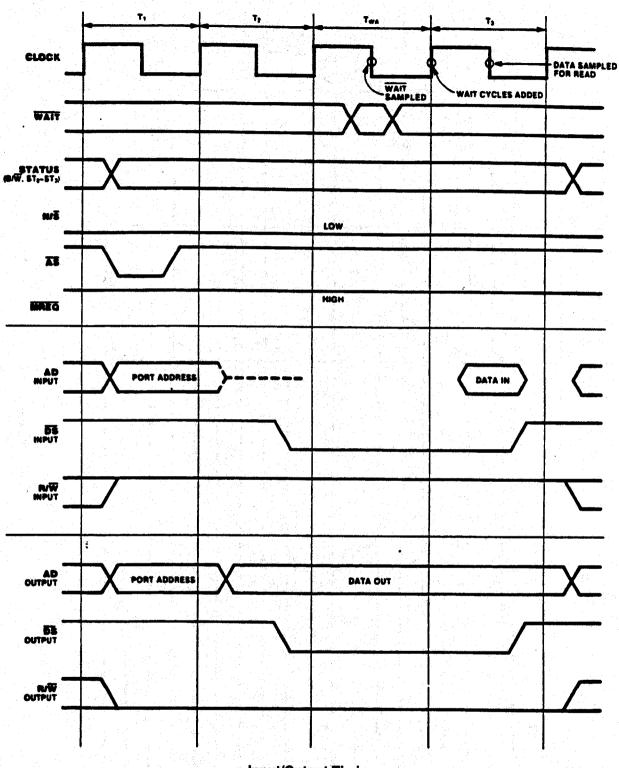


Composite AC Timing

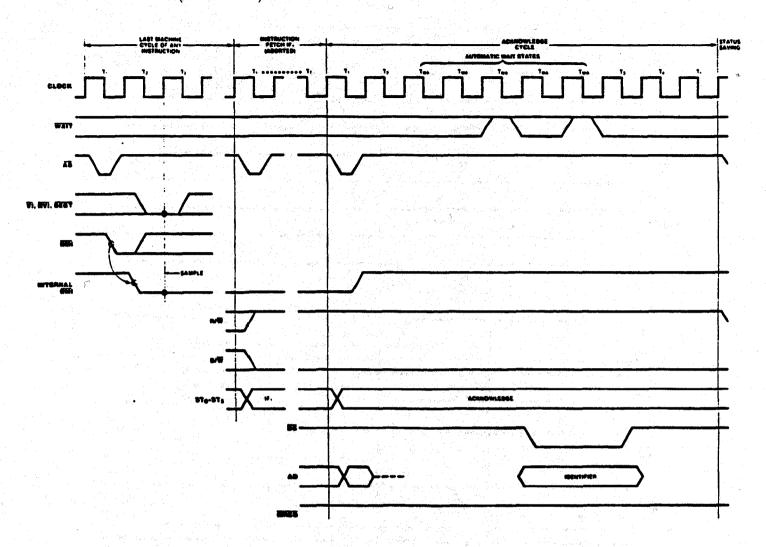
TIMING DIAGRAMS



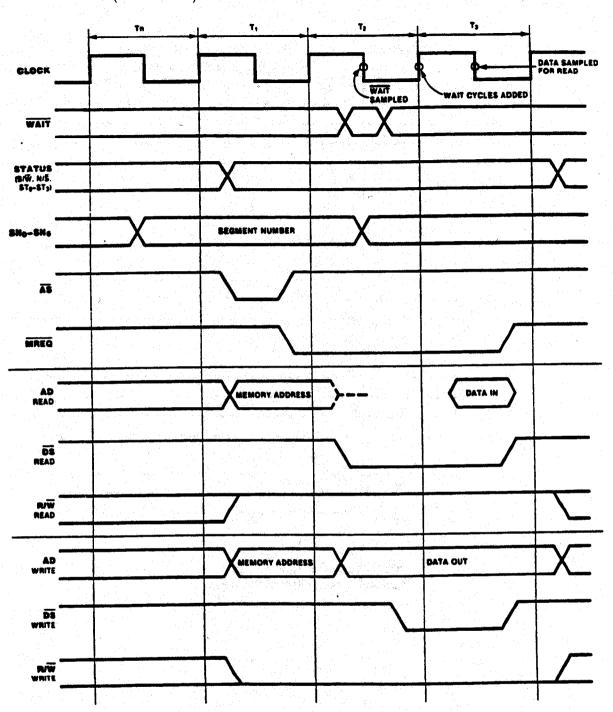
Reset Timing



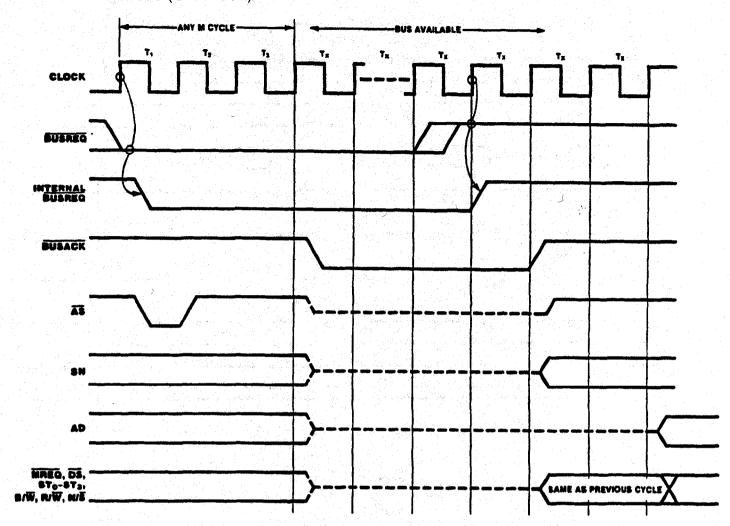
Input/Output Timing



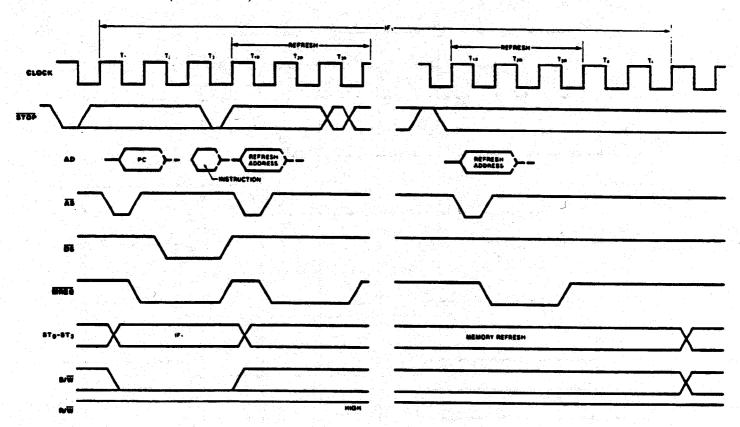
Interrupt and Segment Trap Request/Acknowledge Timing



Memory Read and Write Timing



Bus Request/Acknowledge Timing



Stop Timing

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